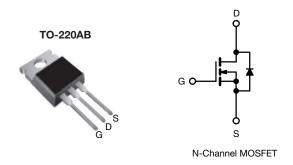


www.vishay.com

Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.263				
Q _g max. (nC)	63				
Q _{gs} (nC)	9				
Q _{gd} (nC)	19				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP17N80AEF-GE3

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _{.1} = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D -	15	
Continuous drain current $(I_j = 150 \text{ C})$	V _{GS} at 10 V	T _C = 100 °C		9	А
Pulsed drain current ^a			I _{DM}	32	
Linear derating factor				1.4	W/°C
Single pulse avalanche energy ^b			E _{AS}	127	mJ
Maximum power dissipation			PD	179	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100	
Reverse diode dv/dt ^d				50	V/ns
Soldering recommendations (peak temperature) c For 10 s				260	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 450 A/µs, starting $T_J = 25 \text{ °C}$

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	0.7	C/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•		•	•	•	•
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μΑ	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	2	-	4	V
		,	$V_{GS} = \pm 20 V$	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zava acto voltago dreia ourrent	1	V _{DS} =	= 640 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	′, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 8.5 A	-	0.263	0.305	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	= 10 V, I _D = 8.5 A	-	8.6	-	S
Dynamic		•		•	•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$		-	1300	-	
Output capacitance	C _{oss}	- ·	$V_{\rm DS} = 100 \rm V,$	-	48	-	1
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	1
Effective output capacitance, energy related	C _{o(er)}			-	39	-	pF
Effective output capacitance, time related	C _{o(tr)}	$v_{\rm DS} = 0$	$v to 480 v, v_{GS} = 0 v$	-	240	-	
Total gate charge	Qg			-	42	63	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 8.5 \text{ A}, V_{DS} = 640 \text{ V}$	-	9	-	nC
Gate-drain charge	Q _{gd}			-	19	-	
Turn-on delay time	t _{d(on)}			-	16	32	
Rise time	t _r	$\begin{array}{c c c c c c c c c c c c c c c c c c c $		40			
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, ${\sf R}_{\sf g}$ = 9.1 Ω	-	32	64	ns
Fall time	t _f			-	38	76	1
Gate input resistance	R _g	f = 1	MHz, open drain	0.2	0.5	1.1	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	
Pulsed diode forward current	I _{SM}			32	- A		
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 8.5 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}	-		-	114	228	ns
Reverse recovery charge	Q _{rr}	$T_{J} = 25$	$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}} = 8.5 \text{A},$	-	0.7	1.4	μC
Reverse recovery current	I _{RRM}		00 A/µs, V _R = 400 V	-	12	-	A

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

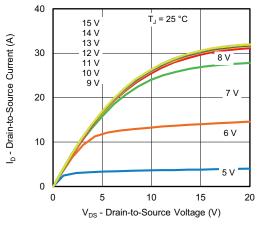


Fig. 1 - Typical Output Characteristics

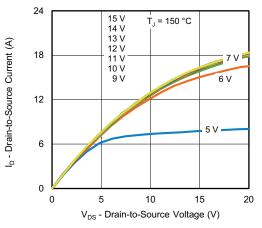


Fig. 2 - Typical Output Characteristics

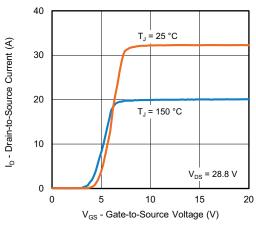


Fig. 3 - Typical Transfer Characteristics

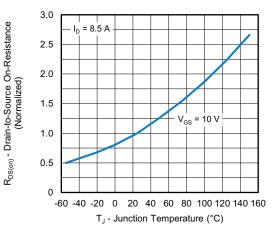


Fig. 4 - Normalized On-Resistance vs. Temperature

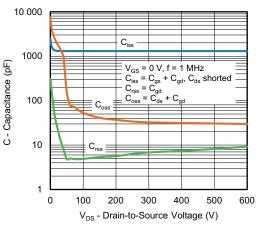
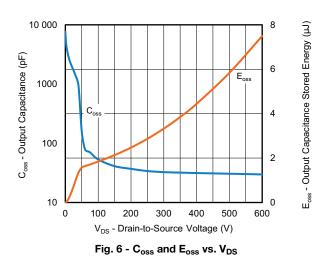


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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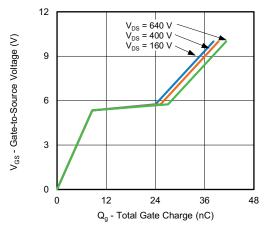


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

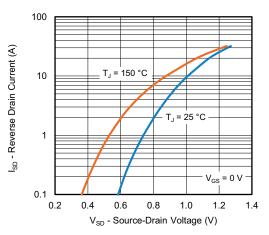


Fig. 8 - Typical Source-Drain Diode Forward Voltage

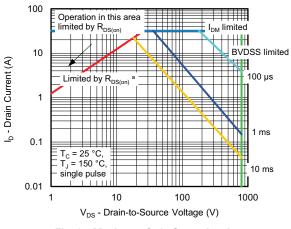


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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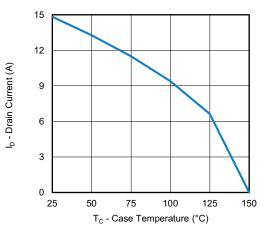


Fig. 10 - Maximum Drain Current vs. Case Temperature

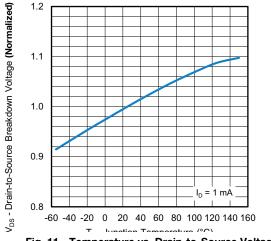


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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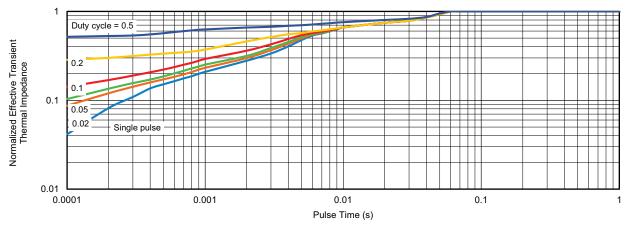


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

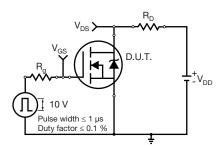


Fig. 13 - Switching Time Test Circuit

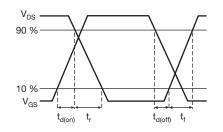


Fig. 14 - Switching Time Waveforms

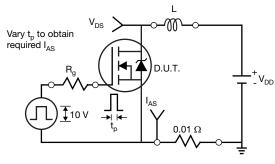


Fig. 15 - Unclamped Inductive Test Circuit

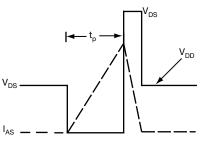


Fig. 16 - Unclamped Inductive Waveforms

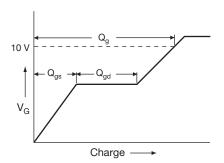
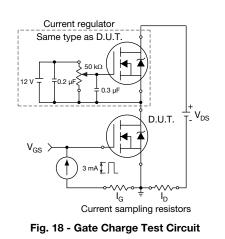


Fig. 17 - Basic Gate Charge Waveform

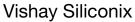


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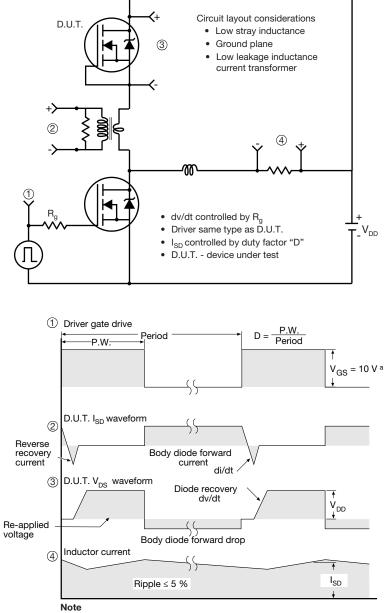
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

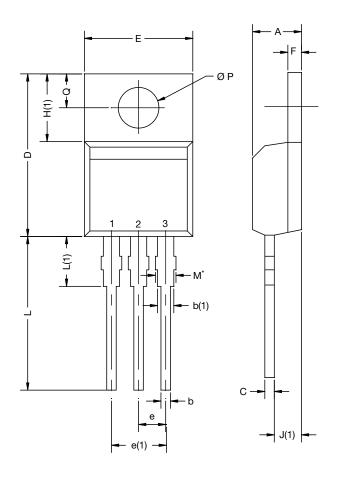
Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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